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Kind regards,

Team Nexperia

# DATA SHEET

## **PDTA124T series**

PNP resistor-equipped transistors;

R1 = 22 k $\Omega$ , R2 = open

Product data sheet  
Supersedes data of 2004 May 05

2004 Aug 04

## PNP resistor-equipped transistors; R1 = 22 k $\Omega$ , R2 = open

## PDTA124T series

### FEATURES

- Built-in bias resistors
- Simplified circuit design
- Reduction of component count
- Reduced pick and place costs.

### APPLICATIONS

- General purpose switching and amplification
- Inverter and interface circuits
- Circuit driver.

### QUICK REFERENCE DATA

| SYMBOL           | PARAMETER                 | TYP. | MAX. | UNIT       |
|------------------|---------------------------|------|------|------------|
| V <sub>CEO</sub> | collector-emitter voltage | –    | –50  | V          |
| I <sub>O</sub>   | output current (DC)       | –    | –100 | mA         |
| R1               | bias resistor             | 22   | –    | k $\Omega$ |
| R2               | open                      | –    | –    | –          |

### DESCRIPTION

PNP resistor-equipped transistor (see “Simplified outline, symbol and pinning” for package details).

### PRODUCT OVERVIEW

| TYPE NUMBER | PACKAGE       |        | MARKING CODE       | NPN COMPLEMENT |
|-------------|---------------|--------|--------------------|----------------|
|             | PHILIPS       | EIAJ   |                    |                |
| PDTA124TE   | SOT416        | SC-75  | 3R                 | PDTC124TE      |
| PDTA124TEF  | SOT490        | SC-89  | 24                 | PDTC124TEF     |
| PDTA124TK   | SOT346        | SC-59  | 59                 | PDTC124TK      |
| PDTA124TM   | SOT883        | SC-101 | DJ                 | PDTC124TM      |
| PDTA124TS   | SOT54 (TO-92) | SC-43  | TA124T             | PDTC124TS      |
| PDTA124TT   | SOT23         | –      | *AE <sup>(1)</sup> | PDTC124TT      |
| PDTA124TU   | SOT323        | SC-70  | *7B <sup>(1)</sup> | PDTC124TU      |

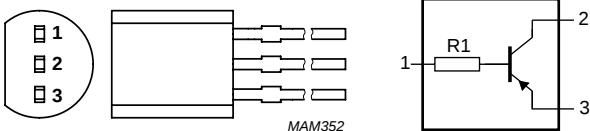
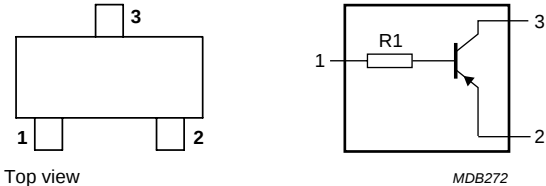
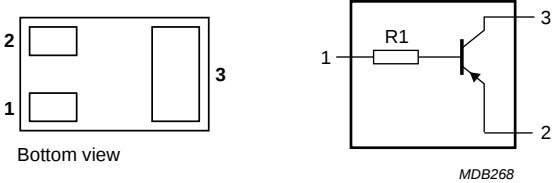
### Note

1. \* = p: Made in Hong Kong.  
\* = t: Made in Malaysia.  
\* = W: Made in China.

PNP resistor-equipped transistors;  
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PDTA124T series

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

| TYPE NUMBER                                                    | SIMPLIFIED OUTLINE AND SYMBOL                                                        | PINNING     |                              |
|----------------------------------------------------------------|--------------------------------------------------------------------------------------|-------------|------------------------------|
|                                                                |                                                                                      | PIN         | DESCRIPTION                  |
| PDTA124TS                                                      |    | 1<br>2<br>3 | base<br>collector<br>emitter |
| PDTA124TE<br>PDTA124TEF<br>PDTA124TK<br>PDTA124TT<br>PDTA124TU |   | 1<br>2<br>3 | base<br>emitter<br>collector |
| PDTA124TM                                                      |  | 1<br>2<br>3 | base<br>emitter<br>collector |

PNP resistor-equipped transistors;  
R1 = 22 k $\Omega$ , R2 = open

PDTA124T series

## ORDERING INFORMATION

| TYPE<br>NUMBER | PACKAGE |                                                                                  |         |
|----------------|---------|----------------------------------------------------------------------------------|---------|
|                | NAME    | DESCRIPTION                                                                      | VERSION |
| PDTA124TE      | –       | plastic surface mounted package; 3 leads                                         | SOT416  |
| PDTA124TEF     | –       | plastic surface mounted package; 3 leads                                         | SOT490  |
| PDTA124TK      | –       | plastic surface mounted package; 3 leads                                         | SOT346  |
| PDTA124TM      | –       | leadless ultra small plastic package; 3 solder lands; body<br>1.0 × 0.6 × 0.5 mm | SOT883  |
| PDTA124TS      | –       | plastic single-ended leaded (through hole) package; 3 leads                      | SOT54   |
| PDTA124TT      | –       | plastic surface mounted package; 3 leads                                         | SOT23   |
| PDTA124TU      | –       | plastic surface mounted package; 3 leads                                         | SOT323  |

## LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

| SYMBOL           | PARAMETER                     | CONDITIONS               | MIN. | MAX. | UNIT |
|------------------|-------------------------------|--------------------------|------|------|------|
| V <sub>CBO</sub> | collector-base voltage        | open emitter             | –    | –50  | V    |
| V <sub>CEO</sub> | collector-emitter voltage     | open base                | –    | –50  | V    |
| V <sub>EBO</sub> | emitter-base voltage          | open collector           | –    | –5   | V    |
| I <sub>O</sub>   | output current (DC)           |                          | –    | –100 | mA   |
| I <sub>CM</sub>  | peak collector current        |                          | –    | –100 | mA   |
| P <sub>tot</sub> | total power dissipation       | T <sub>amb</sub> ≤ 25 °C |      |      |      |
|                  | SOT23                         | note 1                   | –    | 250  | mW   |
|                  | SOT54                         | note 1                   | –    | 500  | mW   |
|                  | SOT323                        | note 1                   | –    | 200  | mW   |
|                  | SOT346                        | note 1                   | –    | 250  | mW   |
|                  | SOT416                        | note 1                   | –    | 150  | mW   |
|                  | SOT490                        | notes 1 and 2            | –    | 250  | mW   |
|                  | SOT883                        | notes 2 and 3            | –    | 250  | mW   |
| T <sub>stg</sub> | storage temperature           |                          | –65  | +150 | °C   |
| T <sub>j</sub>   | junction temperature          |                          | –    | 150  | °C   |
| T <sub>amb</sub> | operating ambient temperature |                          | –65  | +150 | °C   |

## Notes

1. Refer to standard mounting conditions.
2. Reflow soldering is the only recommended soldering method.
3. Refer to SOT883 standard mounting conditions; FR4 with 60  $\mu$ m copper strip line.

PNP resistor-equipped transistors;  
R1 = 22 k $\Omega$ , R2 = open

PDTA124T series

#### THERMAL CHARACTERISTICS

| SYMBOL               | PARAMETER                                   | CONDITIONS    | VALUE | UNIT |
|----------------------|---------------------------------------------|---------------|-------|------|
| R <sub>th(j-a)</sub> | thermal resistance from junction to ambient | in free air   |       |      |
|                      | SOT23                                       | note 1        | 500   | K/W  |
|                      | SOT54                                       | note 1        | 250   | K/W  |
|                      | SOT323                                      | note 1        | 625   | K/W  |
|                      | SOT346                                      | note 1        | 500   | K/W  |
|                      | SOT416                                      | note 1        | 833   | K/W  |
|                      | SOT490                                      | notes 1 and 2 | 500   | K/W  |
|                      | SOT883                                      | notes 2 and 3 | 500   | K/W  |

#### Notes

1. Refer to standard mounting conditions.
2. Reflow soldering is the only recommended soldering method.
3. Refer to SOT883 standard mounting conditions; FR4 with 60  $\mu$ m copper strip line.

#### CHARACTERISTICS

T<sub>amb</sub> = 25 °C unless otherwise specified.

| SYMBOL             | PARAMETER                            | CONDITIONS                                                                   | MIN. | TYP. | MAX. | UNIT       |
|--------------------|--------------------------------------|------------------------------------------------------------------------------|------|------|------|------------|
| I <sub>CBO</sub>   | collector-base cut-off current       | V <sub>CB</sub> = -50 V; I <sub>E</sub> = 0 A                                | –    | –    | -100 | nA         |
| I <sub>CEO</sub>   | collector-emitter cut-off current    | V <sub>CE</sub> = -30 V; I <sub>B</sub> = 0 A                                | –    | –    | -1   | $\mu$ A    |
|                    |                                      | V <sub>CE</sub> = -30 V; I <sub>B</sub> = 0 A;<br>T <sub>j</sub> = 150 °C    | –    | –    | -50  | $\mu$ A    |
| I <sub>EBO</sub>   | emitter-base cut-off current         | V <sub>EB</sub> = -5 V; I <sub>C</sub> = 0 A                                 | –    | –    | -100 | nA         |
| h <sub>FE</sub>    | DC current gain                      | V <sub>CE</sub> = -5 V; I <sub>C</sub> = -1 mA                               | 100  | –    | –    |            |
| V <sub>CEsat</sub> | collector-emitter saturation voltage | I <sub>C</sub> = -10 mA; I <sub>B</sub> = -0.5 mA                            | –    | –    | -150 | mV         |
| R1                 | input resistor                       |                                                                              | 15.4 | 22   | 28.6 | k $\Omega$ |
| C <sub>c</sub>     | collector capacitance                | I <sub>E</sub> = I <sub>e</sub> = 0 A; V <sub>CB</sub> = -10 V;<br>f = 1 MHz | –    | –    | 3    | pF         |

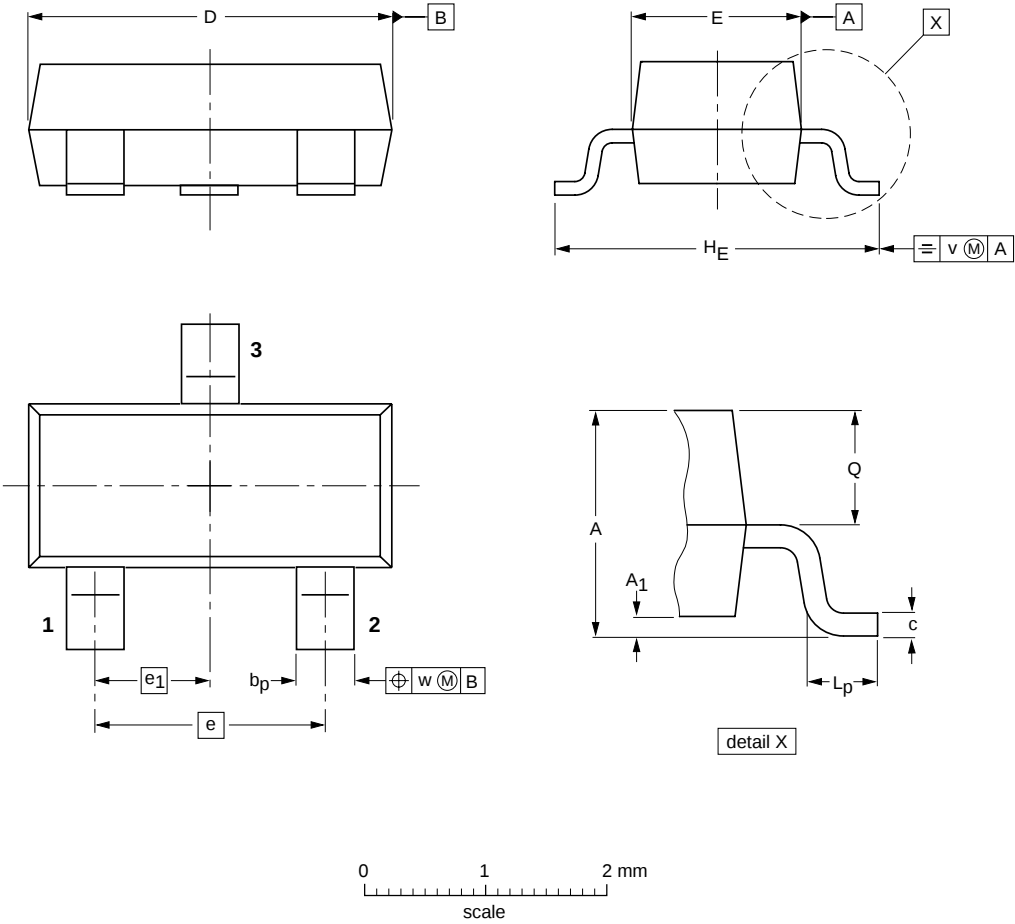
PNP resistor-equipped transistors;  
R1 = 22 kΩ, R2 = open

PDTA124T series

PACKAGE OUTLINES

Plastic surface-mounted package; 3 leads

SOT23



DIMENSIONS (mm are the original dimensions)

| UNIT | A          | A <sub>1</sub><br>max. | b <sub>p</sub> | c            | D          | E          | e   | e <sub>1</sub> | H <sub>E</sub> | L <sub>p</sub> | Q            | v   | w   |
|------|------------|------------------------|----------------|--------------|------------|------------|-----|----------------|----------------|----------------|--------------|-----|-----|
| mm   | 1.1<br>0.9 | 0.1                    | 0.48<br>0.38   | 0.15<br>0.09 | 3.0<br>2.8 | 1.4<br>1.2 | 1.9 | 0.95           | 2.5<br>2.1     | 0.45<br>0.15   | 0.55<br>0.45 | 0.2 | 0.1 |

| OUTLINE<br>VERSION | REFERENCES |          |       |  | EUROPEAN<br>PROJECTION | ISSUE DATE           |
|--------------------|------------|----------|-------|--|------------------------|----------------------|
|                    | IEC        | JEDEC    | JEITA |  |                        |                      |
| SOT23              |            | TO-236AB |       |  |                        | 04-11-04<br>06-03-16 |

PNP resistor-equipped transistors;  
R1 = 22 kΩ, R2 = open

PDTA124T series

Plastic single-ended leaded (through hole) package; 3 leadsSOT54

Technical drawing of the SOT54 package showing top, side, and lead detail views with dimension labels A, b, b<sub>1</sub>, c, D, d, E, e, e<sub>1</sub>, L, L<sub>1</sub>.

0 2.5 5 mm  
scale

**DIMENSIONS (mm are the original dimensions)**

| UNIT | A          | b            | b <sub>1</sub> | c            | D          | d          | E          | e    | e <sub>1</sub> | L            | L <sub>1</sub> <sup>(1)</sup><br>max. |
|------|------------|--------------|----------------|--------------|------------|------------|------------|------|----------------|--------------|---------------------------------------|
| mm   | 5.2<br>5.0 | 0.48<br>0.40 | 0.66<br>0.55   | 0.45<br>0.38 | 4.8<br>4.4 | 1.7<br>1.4 | 4.2<br>3.6 | 2.54 | 1.27           | 14.5<br>12.7 | 2.5                                   |

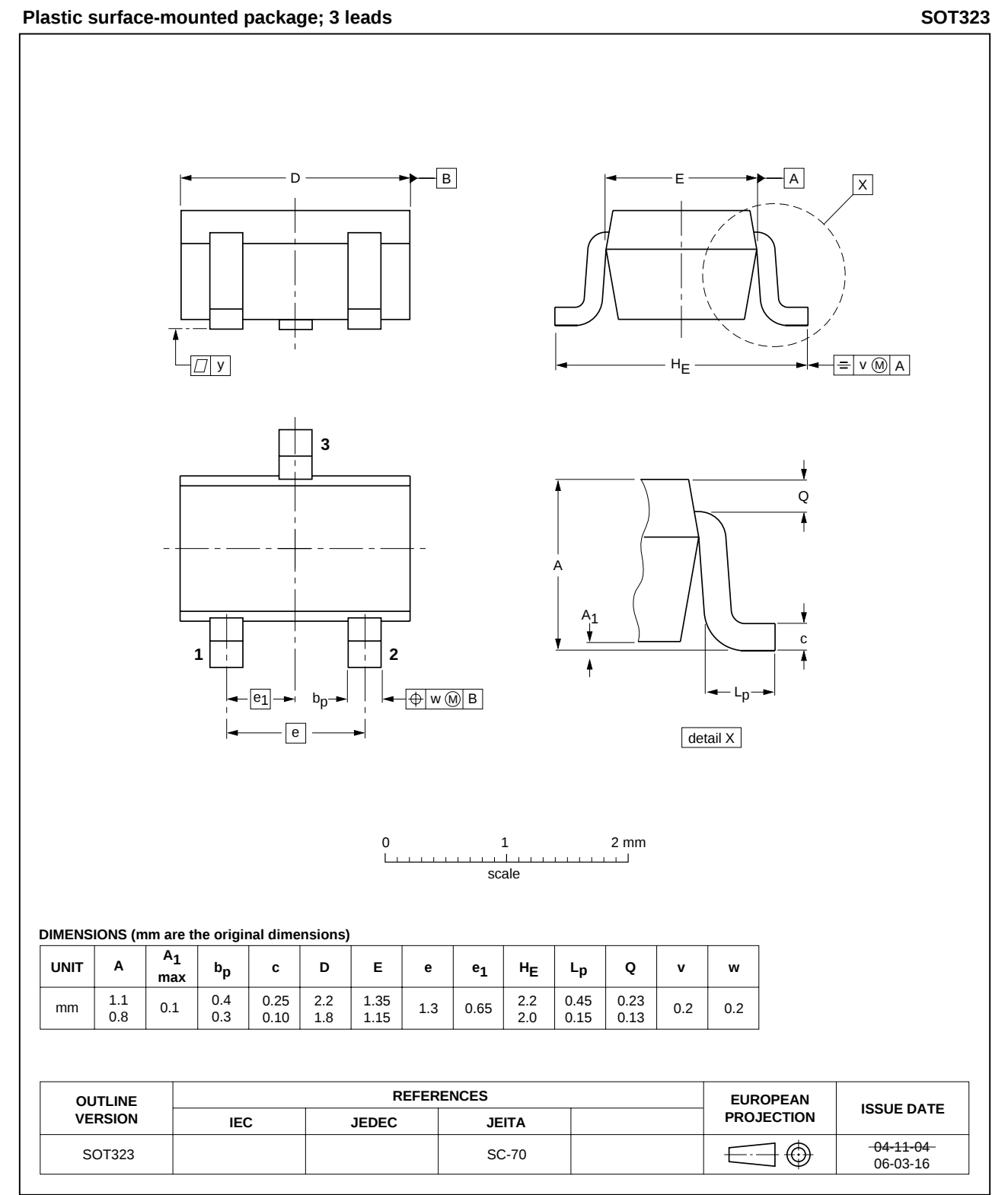
**Note**

1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

| OUTLINE<br>VERSION | REFERENCES |       |        |  | EUROPEAN<br>PROJECTION | ISSUE DATE           |
|--------------------|------------|-------|--------|--|------------------------|----------------------|
|                    | IEC        | JEDEC | JEITA  |  |                        |                      |
| SOT54              |            | TO-92 | SC-43A |  |                        | 04-06-28<br>04-11-16 |

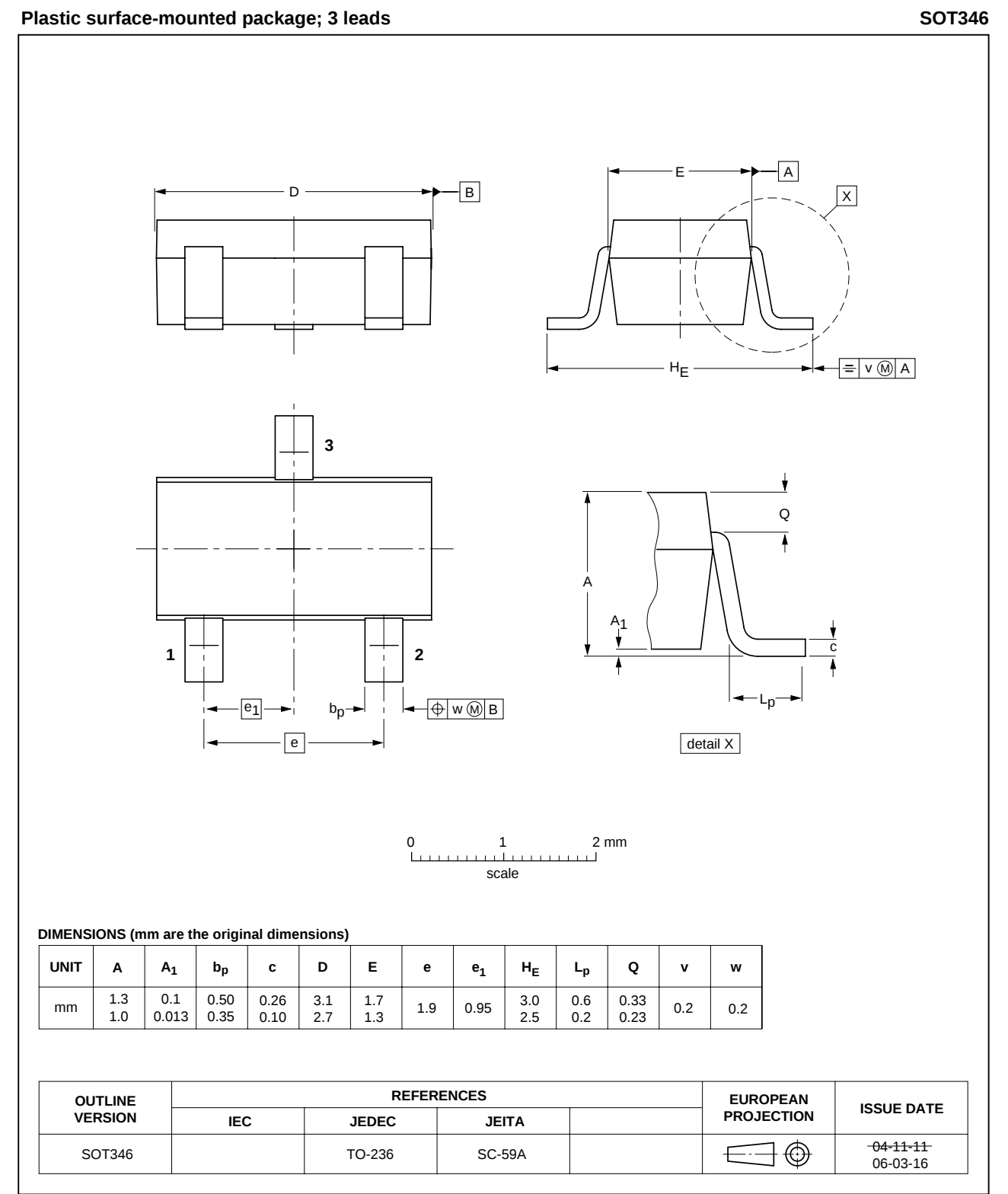
PNP resistor-equipped transistors;  
R1 = 22 kΩ, R2 = open

PDTA124T series



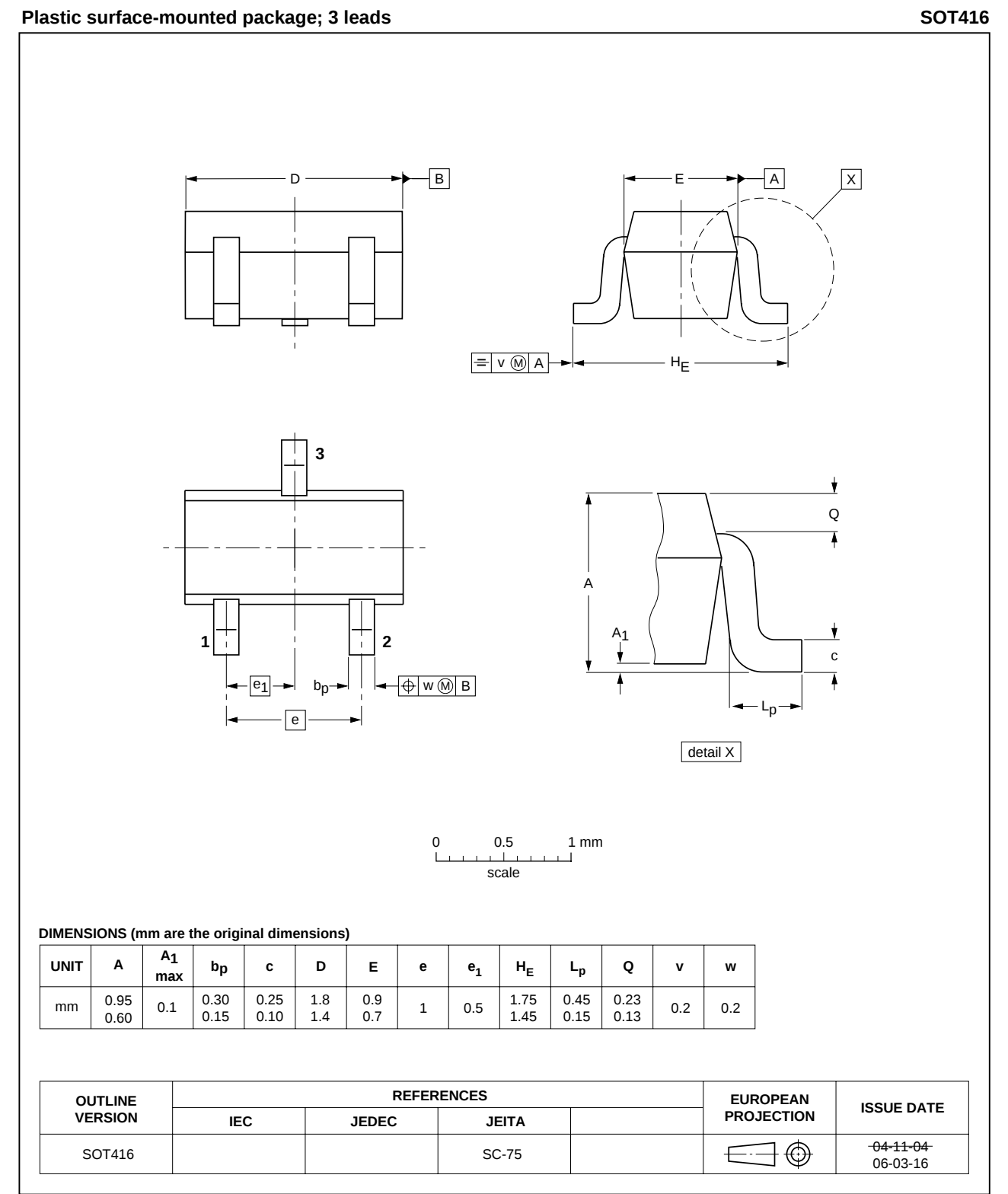
PNP resistor-equipped transistors;  
R1 = 22 kΩ, R2 = open

PDTA124T series



PNP resistor-equipped transistors;  
R1 = 22 kΩ, R2 = open

PDTA124T series

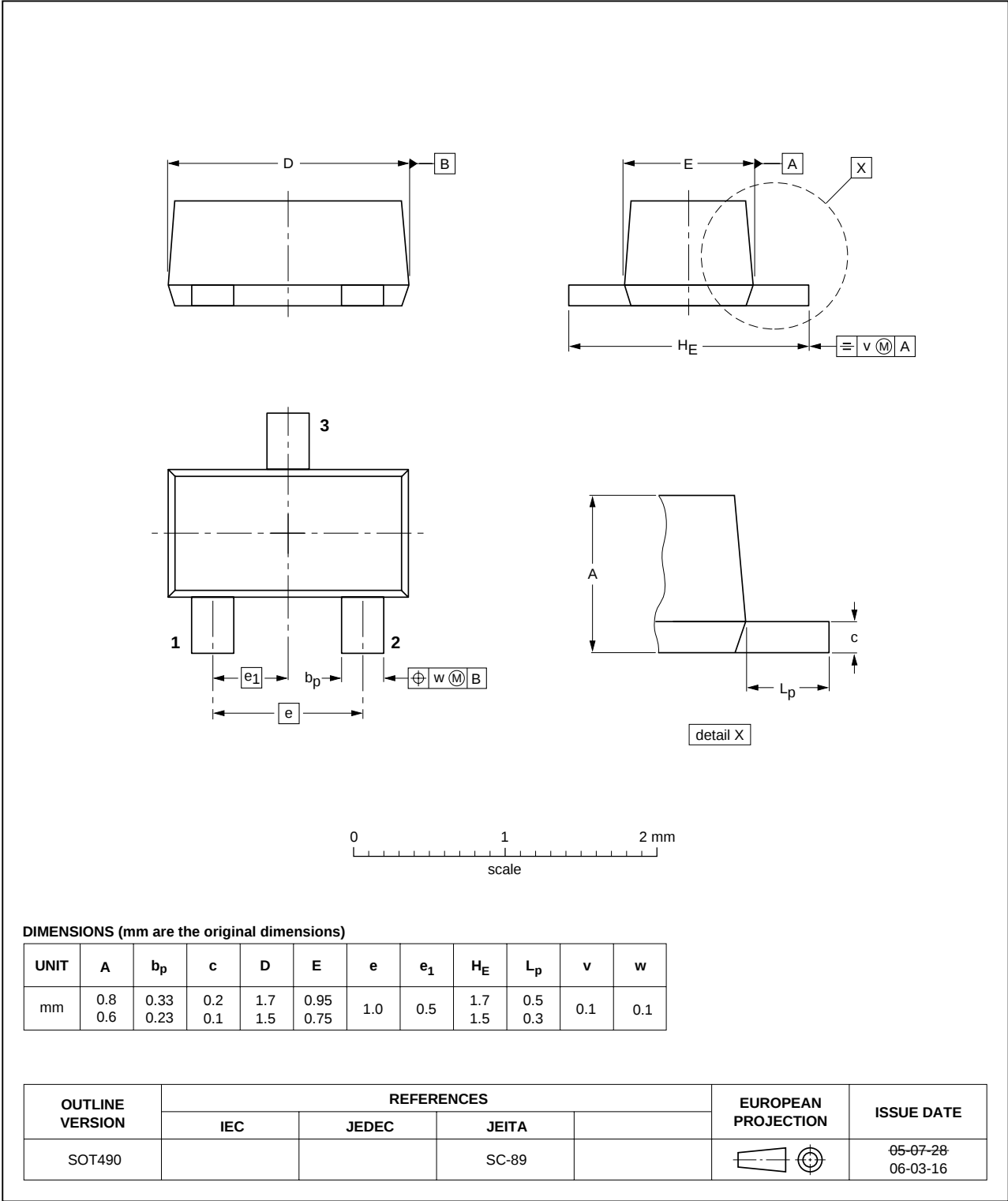


PNP resistor-equipped transistors;  
R1 = 22 kΩ, R2 = open

PDTA124T series

Plastic surface-mounted package; 3 leads

SOT490

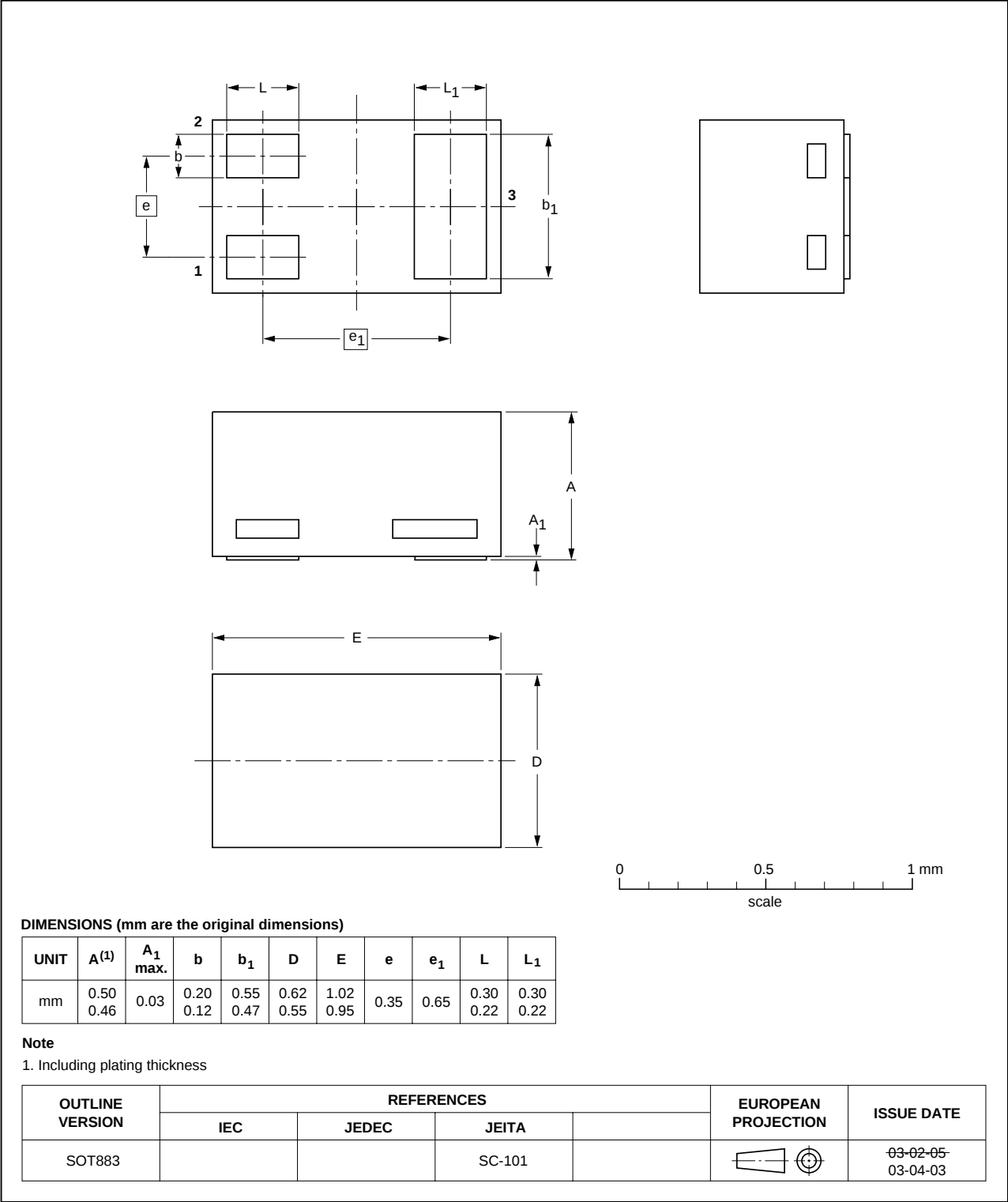


PNP resistor-equipped transistors;  
R1 = 22 kΩ, R2 = open

PDTA124T series

Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.5 mm

SOT883



PNP resistor-equipped transistors;  
R1 = 22 kΩ, R2 = open

PDTA124T series

## DATA SHEET STATUS

| DOCUMENT STATUS <sup>(1)</sup> | PRODUCT STATUS <sup>(2)</sup> | DEFINITION                                                                            |
|--------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective data sheet           | Development                   | This document contains data from the objective specification for product development. |
| Preliminary data sheet         | Qualification                 | This document contains data from the preliminary specification.                       |
| Product data sheet             | Production                    | This document contains the product specification.                                     |

## Notes

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## **Customer notification**

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## **Contact information**

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